#### PATENT ASSIGNMENT

## Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: **NEW ASSIGNMENT** 

**NATURE OF CONVEYANCE: ASSIGNMENT** 

#### **CONVEYING PARTY DATA**

Name	Execution Date
Chuong Anh Tran	01/19/2012

### **RECEIVING PARTY DATA**

Name:	SemiLEDS Optoelectronics Co., Ltd.	
Street Address:	7F, No. 13, Ke Jung Rd.	
Internal Address:	Chu-Nan Site, Hsinchu Science Park	
City:	Chu-Nan, Miao-Li County	
State/Country:	TAIWAN	
Postal Code:	350	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number: 12120768	

#### **CORRESPONDENCE DATA**

Fax Number: (713)623-4846 Phone: 713-623-4844

psdocketing@pattersonsheridan.com, Email: ewilliams@pattersonsheridan.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: PATTERSON & SHERIDAN, L.L.P. 3040 POST OAK BLVD., SUITE 1500 Address Line 1:

HOUSTON, TEXAS 77056 Address Line 4:

ATTORNEY DOCKET NUMBER: SEMI/0053

NAME OF SUBMITTER: Randol W. Read, Reg. #43876

Total Attachments: 2

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<u>PATENT</u> REEL: 027568 FRAME: 0750

501793167

Atty. Docket No.: SEMI/0053

### ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

Lane 81, No. 1 Songcuei Road Hsinchu County 308 Taiwan, ROC	Songcuei Road Hsinchu County 308	
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(hereinafter referred to as Assignors), have invented a certain invention entitled:

# VERTICAL LIGHT-EMITTING DIODE DEVICE STRUCTURE WITH SIXN, LAYER

enclosed herewith or for which application for Letters Patent in the United States was filed on May 15, 2008, under Serial No. 12/120,768, executed on even date herewith; and

WHEREAS, SemiLEDs Optoelectronics Co., Ltd., a corporation of Taiwan, having a place of business at 7F, No. 13, Ke Jung Rd., Chu-Nan Site, Hsinchu Science Park, Chu-Nan 350, Miao-Li County, Taiwan, R.O.C. (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting

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any of said applications; (c) for filing and prosecuting conventional, substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the date indicated below.

1) 70/2.1.19 (DATE)

**CHUONG ANH TRAN**